

DATA SHEET

FB2041

7-bit Futurebus+ transceiver

Product specification

1995 May 25

IC19 Data Handbook

7-bit Futurebus+ transceiver

FB2041

DESCRIPTION

The FB2041 is a 7-bit bidirectional BTL transceiver and is intended to provide the electrical interface to a high performance wired-OR bus. The FB2041 is an inverting transceiver.

The B-port drivers are Low-capacitance open collectors with controlled ramp and are designed to sink 100mA. Precision band gap references on the B-port insure very good noise margins by limiting the switching threshold to a narrow region centered at 1.55V.

FEATURES

- 7-bit BTL transceiver
- Separate I/O on TTL A-port
- Inverting
- Three separate pairs of driver enables in a 1 bit, 3 bit, 3 bit arrangement
- Drives heavily loaded backplanes with equivalent load impedances down to 10Ω.
- High drive 100mA BTL open collector drivers on B-port
- Allows incident wave switching in heavily loaded backplane buses
- Reduced BTL voltage swing produces less noise and reduces power consumption
- Built-in precision band-gap reference provides accurate receiver thresholds and improved noise immunity
- Compatible with IEEE Futurebus+ or proprietary BTL backplanes
- Controlled output ramp and multiple GND pins minimize ground bounce
- Each BTL driver has a dedicated Bus GND for a signal return
- Glitch-free power up/power down operation
- Low I_{CC} current
- Tight output skew
- Supports live insertion
- Pins for the optional JTAG boundary scan function are provided
- High density packaging in plastic Quad Flatpack

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYPICAL	UNIT	
t_{PLH}	Propagation delay	3.7	ns	
t_{PHL}	AIn to \overline{Bn}	2.7		
t_{PLH}	Propagation delay	3.4	ns	
t_{PHL}	\overline{Bn} to AOn	3.2		
C_{OB}	Output capacitance ($\overline{B0} - \overline{B6}$ only)	6	pF	
I_{OL}	Output current ($\overline{B0} - \overline{B6}$ only)	100	mA	
I_{CC}	Supply Current	Standby	19	mA
		AIn to \overline{Bn} (outputs Low or High)	40	
		\overline{Bn} to AOn (outputs Low)	22	
		\overline{Bn} to AOn (outputs High)	19	

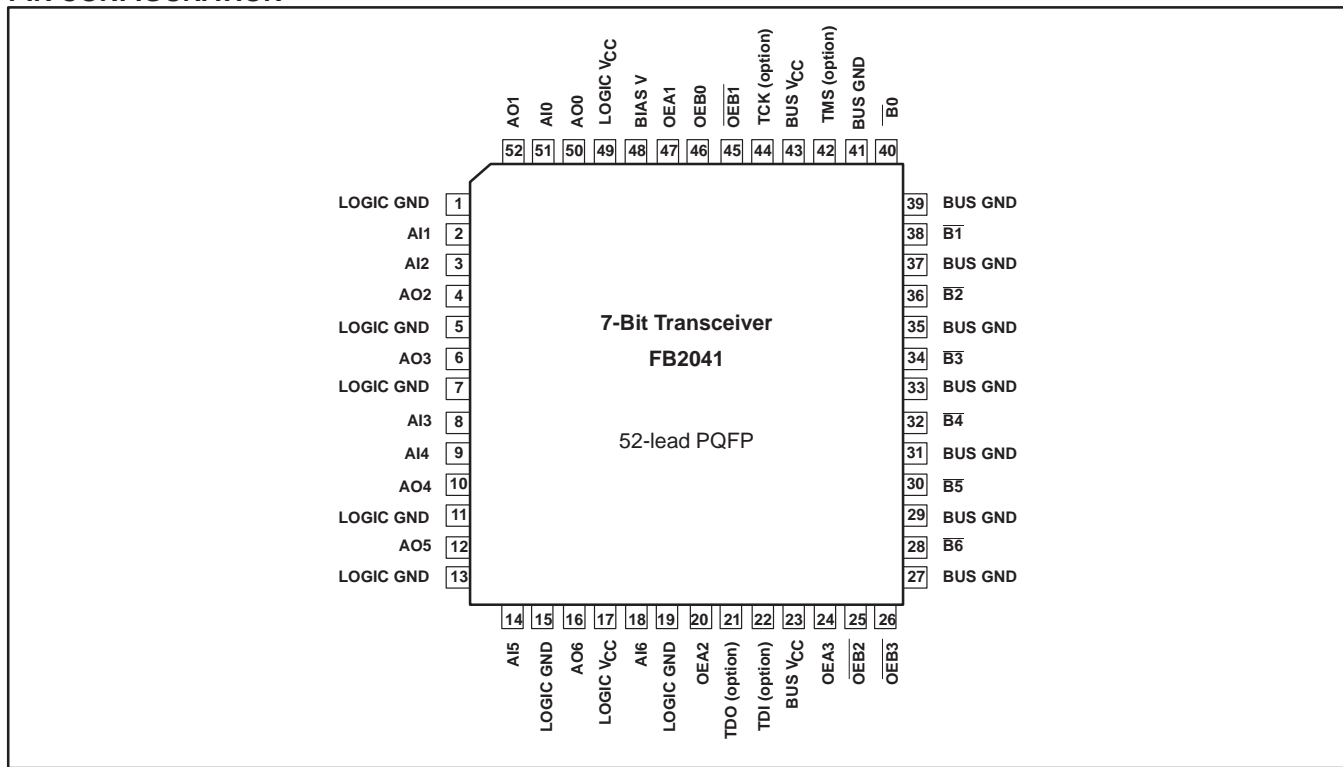
ORDERING INFORMATION

PACKAGE	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$; $T_{amb} = 0$ to $+70^{\circ}C$	INDUSTRIAL RANGE $V_{CC} = 5V \pm 10\%$; $T_{amb} = -40$ to $+85^{\circ}C$	DWG No.
52-pin Plastic Quad Flatpack	FB2041BB	CD3207BB	SOT379-1

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PIN CONFIGURATION



The B-port interfaces to “Backplane Transceiver Logic” (See the IEEE 1194.1 BTL standard). BTL features low power consumption by reducing voltage swing (1Vp-p, between 1V and 2V) and reduced capacitive loading by placing an internal series diode on the drivers. BTL also provides incident wave switching, a necessity for high performance backplanes.

There are three separate pairs of driver enables in a 1 bit, 3 bit, 3 bit arrangement. The TTL/BTL output drivers for bit 0 are enabled with OEA1/OEB1, output drivers for bits 1–2–3 are enabled with OEA2/OEB2 and output drivers for bits 4–5–6 are enabled with OEA3/OEB3.

The A-port operates at TTL levels with separate I/O. The 3-state A-port drivers are enabled when OEAn goes High after an extra 6ns delay which is built in to provide a break-before-make function. When OEAn goes Low, A-port drivers become High impedance without any extra delay. During power on/off cycles, the A-port drivers are held in a High impedance state when VCC is below 2.5V.

The B-port has an output enable, OEB0, which affects all seven drivers. When OEB0 is High and OEBn is Low the output driver will be enabled. When OEB0 is Low or if OEBn is High, the B-port drivers will be inactive and at the level of the backplane signal.

To support live insertion, OEB0 is held Low during power on/off cycles to insure glitch free B port drivers. Proper bias for B port drivers during live insertion is provided by the BIAS V pin when at a 5V level while VCC is Low. If live insertion is not a requirement, the BIAS V pin should be tied to a VCC pin.

The LOGIC GND and BUS GND pins are isolated in the package to minimize noise coupling between the BTL and TTL sides. These pins should be tied to a common ground external to the package.

Each BTL driver has an associated BUS GND pin that acts as a signal return path and these BUS GND pins are internally isolated from each other. In the event of a ground return fault, a “hard” signal failure occurs instead of a pattern dependent error that may be very infrequent and impossible to trouble-shoot.

The LOGIC VCC and BUS VCC pins are also isolated internally to minimize noise and may be externally decoupled separately or simply tied together.

JTAG boundary scan functionality is provided as an option with signals TMS, TCK, TDI and TDO. When this option is not present, TMS and TCK are no-connects (no bond wires) and TDI and TDO are shorted together internally.

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PIN DESCRIPTION

SYMBOL	PIN NUMBER	TYPE	NAME AND FUNCTION
A0 – A16	51, 2, 3, 8, 9, 14, 18	Input	Data inputs (TTL)
AO0 – AO6	50, 52, 4, 6, 10, 12, 16	Output	3-state outputs (TTL)
$\overline{B0} - \overline{B6}$	40, 38, 36, 34, 32, 30, 28	I/O	Data inputs/Open Collector outputs, High current drive (BTL)
OEB0	46	Input	Enables the Bn outputs when High
$\overline{OEB1}$	45	Input	Enables the B0 output when Low
$\overline{OEB2}$	25	Input	Enables the B1 – B3 outputs when Low
$\overline{OEB3}$	26	Input	Enables the B4 – B6 outputs when Low
OEA1	47	Input	Enables the A0 outputs when High
OEA2	20	Input	Enables the A1 – A3 outputs when High
OEA3	24	Input	Enables the A4 – A6 outputs when High
BUS GND	41, 39, 37, 35, 33, 31, 29, 27	GND	Bus ground (0V)
LOGIC GND	1, 5, 7, 11, 13, 15, 19	GND	Logic ground (0V)
BUS V _{CC}	23, 43	Power	Positive supply voltage
LOGIC V _{CC}	17, 49	Power	Positive supply voltage
BIAS V	48	Power	Positive supply voltage
TMS	42	Input	Test Mode Select (no-connect)
TCK	44	Input	Test Clock (no-connect)
TDI	22	Input	Test Data In (shorted to TDO)
TDO	21	Output	Test Data Out (TDI)

ABSOLUTE MAXIMUM RATINGS

Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.

SYMBOL	PARAMETER		RATING	UNIT
V _{CC}	Supply voltage		-0.5 to +7.0	V
V _{IN}	Input voltage	A0 – A16, OEB0, \overline{OEBn} , OEAn	-1.2 to +7.0	V
		$\overline{B0} - \overline{B6}$	-1.2 to +5.5	
I _{IN}	Input current		-18 to +5.0	mA
V _{OUT}	Voltage applied to output in High output state		-0.5 to +V _{CC}	V
I _{OUT}	Current applied to output in Low output state	AO0 – AO6	48	mA
		$\overline{B0} - \overline{B6}$	200	
T _{STG}	Storage temperature		-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	COMMERCIAL LIMITS V _{CC} = 5V±10%; T _{amb} = 0 to +70°C			INDUSTRIAL LIMITS V _{CC} = 5V±10%; T _{amb} = -40 to +85°C			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
V _{CC}	Supply voltage	4.5	5.0	5.5	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	Except $\overline{B0} - \overline{B6}$	2.0		2.0			V
		$\overline{B0} - \overline{B6}$	1.62	1.55	1.62	1.55		
V _{IL}	Low-level input voltage	Except $\overline{B0} - \overline{B6}$		0.8			0.8	V
		$\overline{B0} - \overline{B6}$		1.47			1.47	
I _{IK}	Input clamp current			-18			-18	mA
I _{OH}	High-level output current	AO0 – AO6		-3			-3	mA
I _{OL}	Low-level output current	AO0 – AO6		24			24	mA
		$\overline{B0} - \overline{B6}$		100			100	
C _{OB}	Output capacitance on B port		6	7		6	7	pF
T _{amb}	Operating free-air temperature range	0		+70	-40		+85	°C

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FUNCTION TABLE

MODE	INPUTS									OUTPUTS	
	AIn	Bn*	OEB0	OEB1	OEB2	OEB3	OEA1	OEA2	OEA3	AOn	Bn*
AIn to Bn	L	—	H	L	L	L	L	L	L	Z	H**
	H	—	H	L	L	L	L	L	L	Z	L
	L	—	H	L	L	L	H	H	H	L	H**
	H	—	H	L	L	L	H	H	H	H	L
AI0 to B0	L	—	H	L	X	X	L	L	L	Z	H**
	H	—	H	L	X	X	L	L	L	Z	L
	L	—	H	L	X	X	H	H	H	L	H**
	H	—	H	L	X	X	H	H	H	H	L
AI1 – AI3 to B1 – B3	L	—	H	X	L	X	L	L	L	Z	H**
	H	—	H	X	L	X	L	L	L	Z	L
	L	—	H	X	L	X	H	H	H	L	H**
	H	—	H	X	L	X	H	H	H	H	L
AI4 – AI6 to B4 – B6	L	—	H	X	X	L	L	L	L	Z	H**
	H	—	H	X	X	L	L	L	L	Z	L
	L	—	H	X	X	L	H	H	H	L	H**
	H	—	H	X	X	L	H	H	H	H	L
Disable Bn outputs	X	X	L	X	X	X	X	X	X	X	H**
	X	X	X	H	H	H	X	X	X	X	H**
Disable B0 outputs	X	X	H	H	X	X	X	X	X	X	H**
Disable B1 – B3 outputs	X	X	H	X	H	X	X	X	X	X	H**
Disable B4 – B6 outputs	X	X	H	X	X	H	X	X	X	X	H**
Bn to AOn	X	L	L	X	X	X	H	H	H	H	Input
	X	H	L	X	X	X	H	H	H	L	Input
	X	L	X	H	H	H	H	H	H	H	Input
	X	H	X	H	H	H	H	H	H	L	Input
B0 to AO0	X	L	L	X	X	X	H	X	X	H	Input
	X	H	L	X	X	X	H	X	X	L	Input
	X	L	X	H	H	H	H	X	X	H	Input
	X	H	X	H	H	H	H	X	X	L	Input
B1 – B3 to AO1 – AO3	X	L	L	X	X	X	X	H	X	H	Input
	X	H	L	X	X	X	X	H	X	L	Input
	X	L	X	H	H	H	X	H	X	H	Input
	X	H	X	H	H	H	X	H	X	L	Input
B4 – B6 to AO4 – AO6	X	L	L	X	X	X	X	X	H	H	Input
	X	H	L	X	X	X	X	X	H	L	Input
	X	L	X	H	H	H	X	X	H	H	Input
	X	H	X	H	H	H	X	X	H	L	Input
Disable AOn outputs	X	X	X	X	X	X	L	L	L	Z	X
Disable AO0 outputs	X	X	X	X	X	X	L	X	X	Z	X
Disable AO1 – AO3 outputs	X	X	X	X	X	X	X	L	X	Z	X
Disable AO4 – AO6 outputs	X	X	X	X	X	X	X	X	L	Z	X

NOTES:

H = High voltage level

L = Low voltage level

X = Don't care

Z = High-impedance (OFF) state

— = Input not externally driven

H** = Goes to level of pull-up voltage

B* = Precaution should be taken to ensure B inputs do not float.
If they do, they are equal to Low state.

Z = High-impedance (OFF) state

— = Input not externally driven

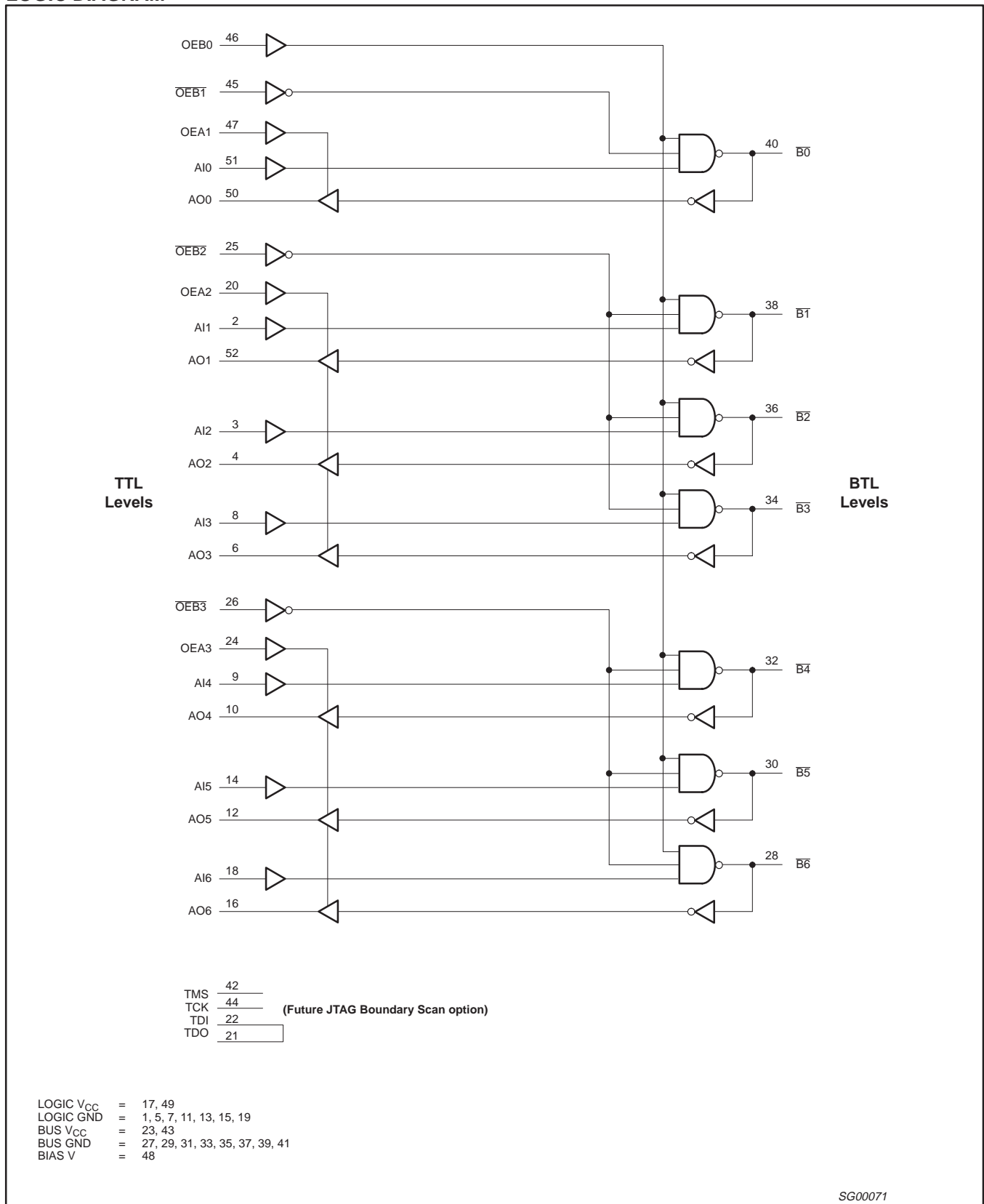
H** = Goes to level of pull-up voltage

B* = Precaution should be taken to ensure B inputs do not float.
If they do, they are equal to Low state.

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LOGIC DIAGRAM



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LIVE INSERTION SPECIFICATIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	TYP	MAX	
V_{BIASV}	Bias pin voltage	$V_{CC} = 0$ to 5.25V, $\overline{Bn} = 0$ to 2.0V	4.5		5.5	V
I_{BIASV}	Bias pin DC current	$V_{CC} = 0$ to 4.75V, $\overline{Bn} = 0$ to 2.0V, Bias V = 4.5 to 5.5V			1	mA
		$V_{CC} = 4.5$ to 5.5V, $\overline{Bn} = 0$ to 2.0V, Bias V = 4.5 to 5.5V			10	μ A
\overline{V}_{Bn}	Bus voltage during prebias	$\overline{B0} - \overline{B8} = 0V$, Bias V = 5.0V	1.62		2.1	V
I_{LM}	Fall current during prebias	$\overline{B0} - \overline{B8} = 2V$, Bias V = 4.5 to 5.5V	1			μ A
I_{HM}	Rise current during prebias	$\overline{B0} - \overline{B8} = 1V$, Bias V = 4.5 to 5.5V	-1			μ A
\overline{I}_{BnPEAK}	Peak bus current during insertion	$V_{CC} = 0$ to 5.25V, $\overline{B0} - \overline{B8} = 0$ to 2.0V, Bias V = 4.5 to 5.5V, $OEB0 = 0.8V$, $t_r = 2ns$			10	mA
I_{OLOFF}	Power up current	$V_{CC} = 0$ to 5.25V, $OEB0 = 0.8V$			100	μ A
		$V_{CC} = 0$ to 2.2V, $OEB0 = 0$ to 5V			100	
t_{GR}	Input glitch rejection	$V_{CC} = 5.0V$	1.0	1.35		ns

DC ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range unless otherwise noted.

SYMBOL	PARAMETER		TEST CONDITIONS ¹	LIMITS			UNIT
				MIN	TYP ²	MAX	
I_{OH}	High level output current	$\overline{B0} - \overline{B6}$	$V_{CC} = MAX$, $V_{IL} = MAX$, $V_{IH} = MIN$, $V_{OH} = 2.1V$			100	μ A
I_{OFF}	Power-off output current	$\overline{B0} - \overline{B6}$	$V_{CC} = 0.0V$, $V_{IL} = MAX$, $V_{IH} = MIN$, $V_{OH} = 2.1V$			100	μ A
V_{OH}	High-level output voltage	$AO0 - AO6$ ³	$V_{CC} = MIN$, $V_{IL} = MAX$, $V_{IH} = MIN$, $I_{OH} = -3mA$	2.5	2.85		V
V_{OL}	Low-level output voltage	$AO0 - AO6$ ³	$V_{CC} = MIN$, $V_{IL} = MAX$, $V_{IH} = MIN$, $I_{OL} = 24mA$		0.33	0.5	V
		$\overline{B0} - \overline{B6}$	$V_{CC} = MIN$, $V_{IL} = MAX$, $V_{IH} = MIN$, $I_{OL} = 80mA$.75	1.0	1.10	
			$V_{CC} = MIN$, $V_{IL} = MAX$, $V_{IH} = MIN$, $I_{OL} = 100mA$			1.15	
V_{IK}	Input clamp voltage		$V_{CC} = MIN$, $I_I = I_{IK}$			-1.2	V
I_I	Input current at maximum input voltage	$OEB0$, \overline{OEBn} , OEA_n , $A_{I0} - A_{I6}$	$V_{CC} = MAX$, $V_I = GND$ or 5.5V			± 50	μ A
I_{IH}	High-level input current	$OEB0$, \overline{OEBn} , OEA_n , $A_{I0} - A_{I6}$	$V_{CC} = MAX$, $V_I = 2.7V$			20	μ A
		$\overline{B0} - \overline{B6}$	$V_{CC} = MAX$, $V_I = 2.1V$			100	
I_{IL}	Low-level input current	$OEB0$, \overline{OEBn} , OEA_n , $A_{I0} - A_{I6}$	$V_{CC} = MAX$, $V_I = 0.5V$			-20	μ A
		$\overline{B0} - \overline{B6}$	$V_{CC} = MAX$, $V_I = 0.75V$			-100	
I_{OZH}	Off-state output current	$AO0 - AO6$	$V_{CC} = MAX$, $V_O = 2.7V$			50	μ A
I_{OZL}	Off-state output current	$AO0 - AO6$	$V_{CC} = MAX$, $V_O = 0.5V$			-50	μ A
I_O	Output current	$AO0 - AO6$ only	$V_{CC} = MAX$	-30	-55	-150	mA
I_{CC}	Supply current (total)	I_{CCZ} (standby)	$V_{CC} = MAX$		19	30	mA
		I_{CCB} , A_{In} to \overline{Bn}	$V_{CC} = MAX$, outputs Low or High		40	60	
		I_{CCA} , \overline{Bn} to AOn	$V_{CC} = MAX$, outputs Low		22	35	
		I_{CCA} , \overline{Bn} to AOn	$V_{CC} = MAX$, outputs High		19	35	

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operation conditions for the applicable type.
- All typical values are at $V_{CC} = 5V$, $T_A = 25^\circ C$.
- Due to test equipment limitations, actual test conditions are $V_{IH} = 1.8V$ and $V_{IL} = 1.3V$ for the B side.

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AC ELECTRICAL CHARACTERISTICS (Commercial)

SYMBOL	PARAMETER	TEST CONDITION	A PORT LIMITS					UNIT
			$T_{amb} = +25^{\circ}\text{C}, V_{CC} = 5\text{V}, C_L = 50\text{pF}, R_L = 500\Omega$			$T_{amb} = 0 \text{ to } 70^{\circ}\text{C}, V_{CC} = 5\text{V}\pm 10\%, C_L = 50\text{pF}, R_L = 500\Omega$		
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, \overline{Bn} to AOn	Waveform 1, 2	1.8 1.6	3.4 3.2	5.0 4.9	1.6 1.6	5.5 5.0	ns
t_{PZH} t_{PZL}	Output enable time, OEA to AOn	Waveform 4, 5	2.2 2.0	5.0 4.0	6.5 6.5	2.0 1.8	10.0 8.0	ns
t_{PHZ} t_{PLZ}	Output disable time, OEA to AOn	Waveform 4, 5	1.5 1.8	3.3 3.0	4.8 5.0	1.2 1.5	5.0 5.5	ns
t_{TLH} t_{THL}	Transition time, AOn Port (10% to 90% or 90% to 10%)	Test Circuit and Waveforms	1.5 1.5	2.2 2.4	3.0 3.0	1.5 1.5	3.5 3.5	ns
$t_{sk(o)}$	Output skew between receivers in same package ¹	Waveform 3		0.4	1.0		1.0	ns
SYMBOL	PARAMETER	TEST CONDITION	B PORT LIMITS					UNIT
			$T_{amb} = +25^{\circ}\text{C}, V_{CC} = 5\text{V}, C_D = 30\text{pF}, R_U = 9\Omega$			$T_{amb} = 0 \text{ to } 70^{\circ}\text{C}, V_{CC} = 5\text{V}\pm 10\%, C_D = 30\text{pF}, R_U = 9\Omega$		
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, AIn to \overline{Bn}	Waveform 1, 2	2.4 1.5	3.7 2.7	4.9 4.4	1.9 1.5	5.7 5.0	ns
t_{PLH} t_{PHL}	Enable/disable time, OEB0 to \overline{Bn}	Waveform 2	2.4 1.9	3.7 3.5	4.9 4.9	1.9 1.8	6.4 5.4	ns
t_{PLH} t_{PHL}	Enable/disable time, OEB1 to \overline{Bn}	Waveform 1	2.4 1.9	4.0 3.6	5.5 5.5	1.9 2.5	5.9 5.9	ns
t_{TLH} t_{THL}	Transition time, \overline{Bn} Port (1.3V to 1.8V)	Test Circuit and Waveforms	1.0 0.5	1.4 1.1	3.0 3.0	1.0 0.5	3.0 3.0	ns
$t_{sk(o)}$	Output skew between drivers in same package ¹	Waveform 3		0.3	1.0		1.0	ns
SYMBOL	PARAMETER	TEST CONDITION	$R_U = 16.5\Omega$			$R_U = 16.5\Omega$		UNIT
t_{PLH} t_{PHL}	Propagation delay, AIn to \overline{Bn}	Waveform 1, 2	2.5 1.6	3.8 2.8	5.0 4.5	2.0 1.6	5.8 5.1	ns
t_{PLH} t_{PHL}	Enable/disable time, OEB0 to \overline{Bn}	Waveform 2	2.5 2.0	3.8 3.6	5.0 5.0	2.0 1.9	6.5 5.5	ns
t_{PLH} t_{PHL}	Enable/disable time, OEB1 to \overline{Bn}	Waveform 1	2.5 2.0	4.1 3.7	5.6 5.6	2.0 2.6	6.0 6.0	ns
t_{TLH} t_{THL}	Transition time, \overline{Bn} Port (1.3V to 1.8V)	Test Circuit and Waveforms	1.0 0.5	1.5 1.1	3.0 3.0	1.0 0.5	3.0 3.0	ns
$t_{sk(o)}$	Output skew between drivers in same package ¹	Waveform 3		0.3	1.0		1.0	ns

NOTES:

- $|t_{PNactual} - t_{PMactual}|$ for any data input to output path compared to any other data input to output path where N and M are either LH or HL. Skew times are valid only under same test conditions (temperature, V_{CC} , loading, etc.).

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AC ELECTRICAL CHARACTERISTICS (Industrial)

SYMBOL	PARAMETER	TEST CONDITION	A PORT LIMITS					UNIT
			$T_{amb} = +25^{\circ}\text{C}, V_{CC} = 5\text{V}, C_L = 50\text{pF}, R_L = 500\Omega$			$T_{amb} = -40 \text{ to } +85^{\circ}\text{C}, V_{CC} = 5\text{V}\pm 10\%, C_L = 50\text{pF}, R_L = 500\Omega$		
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, \overline{Bn} to AOn	Waveform 1, 2	1.8 1.6	3.4 3.2	5.0 4.9	1.6 1.6	5.5 5.5	ns
t_{PZH} t_{PZL}	Output enable time, OEA to AOn	Waveform 4, 5	2.2 2.0	5.0 4.0	6.5 6.5	1.5 1.5	8.0 8.0	ns
t_{PHZ} t_{PLZ}	Output disable time, OEA to AOn	Waveform 4, 5	1.5 1.5	3.3 3.0	4.8 5.0	0.8 1.2	6.0 6.0	ns
t_{TLH} t_{THL}	Transition time, AOn Port (10% to 90% or 90% to 10%)	Test Circuit and Waveforms	1.5 1.5	2.2 2.4	3.0 3.0	1.5 1.5	3.5 3.5	ns
$t_{sk(o)}$	Output skew between receivers in same package ¹	Waveform 3		0.4	1.0		1.0	ns
SYMBOL	PARAMETER	TEST CONDITION	B PORT LIMITS					UNIT
			$T_{amb} = +25^{\circ}\text{C}, V_{CC} = 5\text{V}, C_D = 30\text{pF}, R_U = 9\Omega$			$T_{amb} = -40 \text{ to } +85^{\circ}\text{C}, V_{CC} = 5\text{V}\pm 10\%, C_D = 30\text{pF}, R_U = 9\Omega$		
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, AIn to \overline{Bn}	Waveform 1, 2	2.4 1.5	3.7 2.7	4.9 4.4	1.9 1.5	5.9 5.0	ns
t_{PLH} t_{PHL}	Enable/disable time, OEB0 to \overline{Bn}	Waveform 2	2.4 1.9	3.7 3.5	4.9 4.9	1.9 1.8	6.4 5.9	ns
t_{PLH} t_{PHL}	Enable/disable time, OEB1 to \overline{Bn}	Waveform 1	2.4 1.9	4.0 3.6	5.5 5.5	1.9 1.5	6.8 6.8	ns
t_{TLH} t_{THL}	Transition time, \overline{Bn} Port (1.3V to 1.8V)	Test Circuit and Waveforms	1.0 0.5	1.4 1.1	3.0 3.0	1.0 0.5	3.0 3.0	ns
$t_{sk(o)}$	Output skew between drivers in same package ¹	Waveform 3		0.3	1.0		1.0	ns
SYMBOL	PARAMETER	TEST CONDITION	$R_U = 16.5\Omega$			$R_U = 16.5\Omega$		UNIT
t_{PLH} t_{PHL}	Propagation delay, AIn to \overline{Bn}	Waveform 1, 2	2.5 1.6	3.8 2.8	5.0 4.5	2.0 1.6	6.0 5.1	ns
t_{PLH} t_{PHL}	Enable/disable time, OEB0 to \overline{Bn}	Waveform 2	2.5 2.0	3.8 3.6	5.0 5.0	2.0 1.9	6.5 6.0	ns
t_{PLH} t_{PHL}	Enable/disable time, OEB1 to \overline{Bn}	Waveform 1	2.5 2.0	4.1 3.7	5.5 5.5	2.0 1.6	6.9 6.9	ns
t_{TLH} t_{THL}	Transition time, \overline{Bn} Port (1.3V to 1.8V)	Test Circuit and Waveforms	1.0 0.5	1.5 1.1	3.0 3.0	1.0 0.5	3.0 3.0	ns
$t_{sk(o)}$	Output skew between drivers in same package ¹	Waveform 3		0.3	1.0		1.0	ns

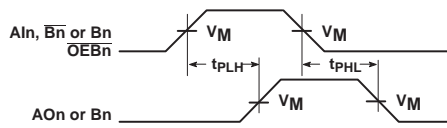
NOTES:

- $|t_{PNactual} - t_{PMactual}|$ for any data input to output path compared to any other data input to output path where N and M are either LH or HL. Skew times are valid only under same test conditions (temperature, V_{CC} , loading, etc.).

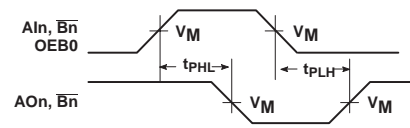
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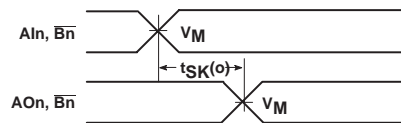
AC WAVEFORMS



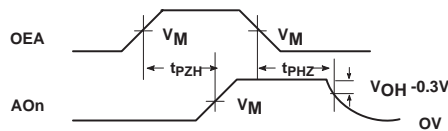
Waveform 1. Propagation Delay for Data or Output Enable to Output



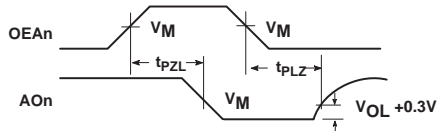
Waveform 2. Propagation Delay for Data or Output Enable to Output



Waveform 3. Output Skews



Waveform 4. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 5. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

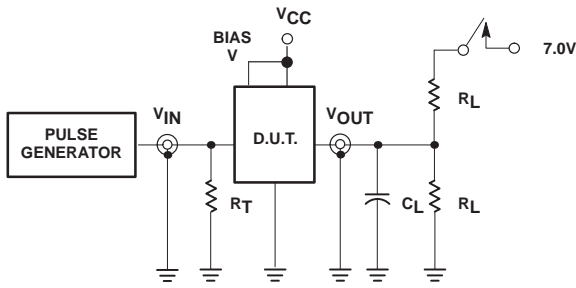
NOTE: $V_M = 1.55V$ for \overline{Bn} , $V_M = 1.5V$ for all others.

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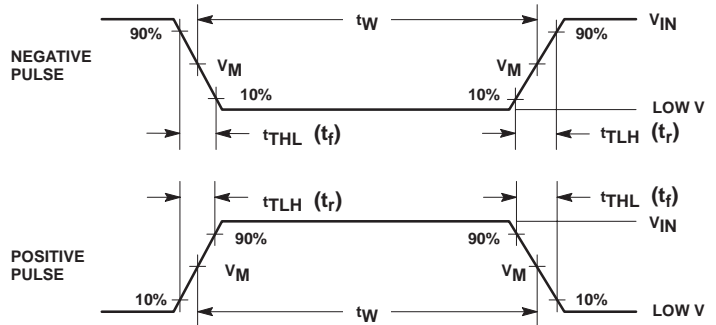
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TEST CIRCUIT AND WAVEFORMS



Test Circuit for 3-State Outputs on A Port

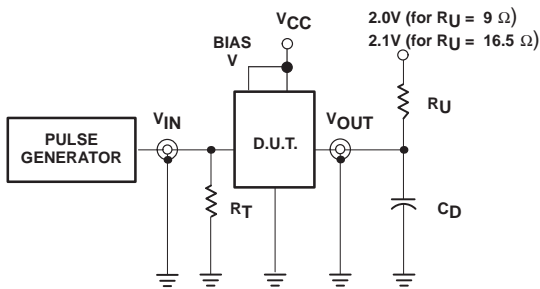


$V_M = 1.55V$ for \overline{Bn} , $V_M = 1.5V$ for all others.
Input Pulse Definitions

SWITCH POSITION

TEST	SWITCH
t_{PLZ} , t_{PZL}	closed
All other	open

Family FB+	INPUT PULSE REQUIREMENTS					
	Amplitude	Low V	Rep. Rate	t_W	t_{TLH}	t_{THL}
A Port	3.0V	0.0V	1MHz	500ns	2.5ns	2.5ns
B Port	2.0V	1.0V	1MHz	500ns	2.5ns	2.5ns



Test Circuit for Outputs on B Port

DEFINITIONS:

- R_L = Load Resistor; see AC CHARACTERISTICS for value.
- C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
- R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.
- C_D = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
- R_U = Pull up resistor; see AC CHARACTERISTICS for value.

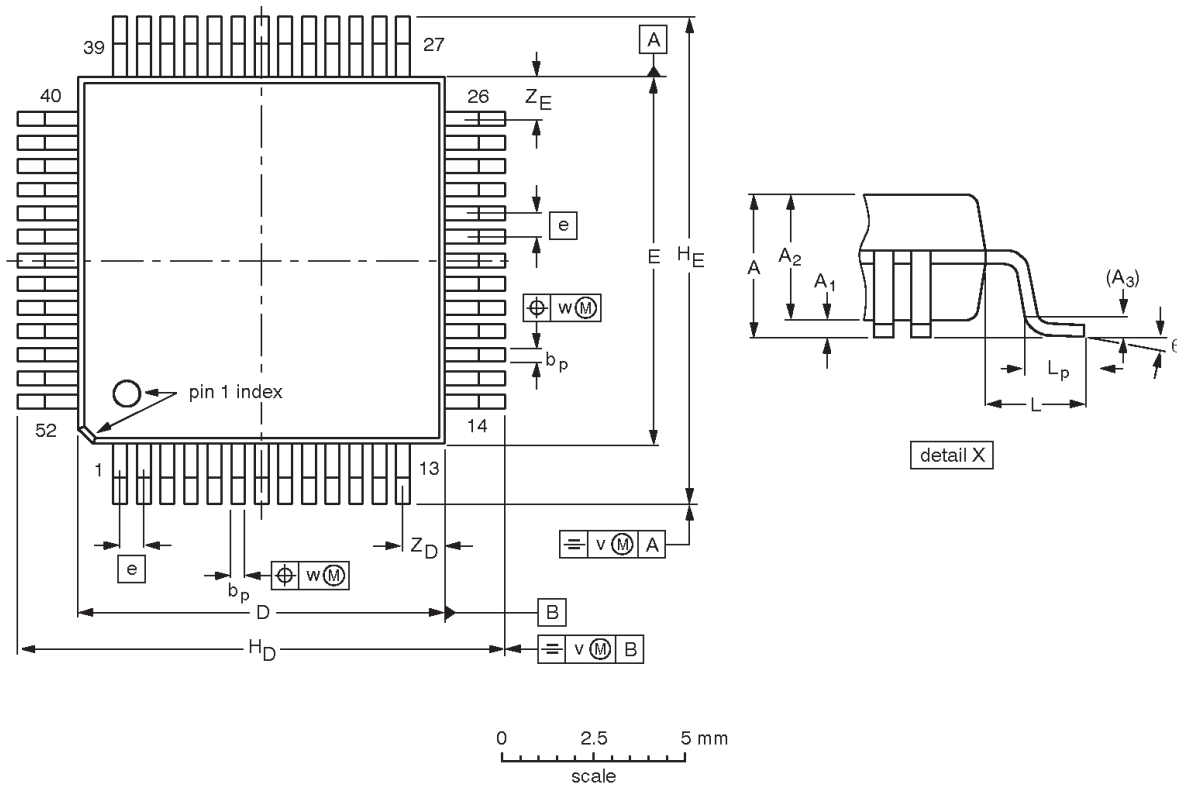
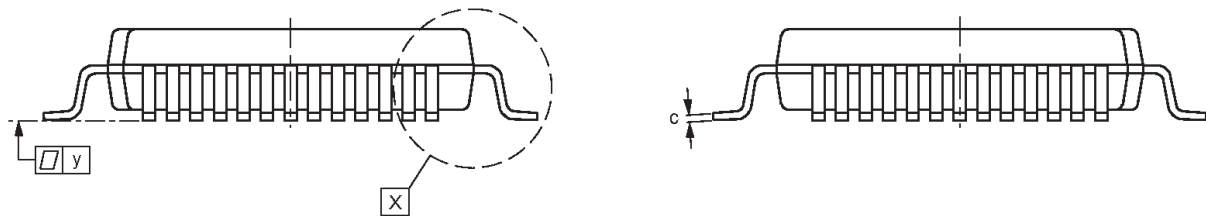
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QFP52: plastic quad flat package; 52 leads (lead length 1.6 mm); body 10 x 10 x 2.0 mm

SOT379-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _D	H _E	L	L _p	v	w	y	Z _D ⁽¹⁾	Z _E ⁽¹⁾	θ
mm	2.45	0.45 0.25	2.10 1.95	0.25	0.38 0.22	0.23 0.13	10.1 9.9	10.1 9.9	0.65	13.45 12.95	13.45 12.95	1.60	0.95 0.65	0.20	0.12	0.10	1.24 0.95	1.24 0.95	7° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOT379-1		MO-108			95-02-04 97-08-04

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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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